

SDB1045HB

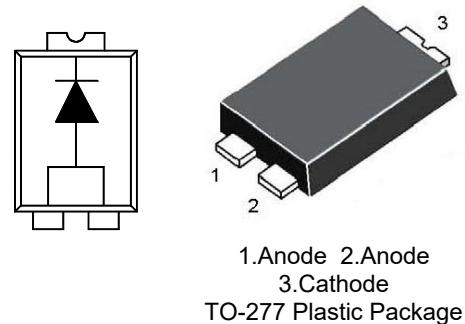
Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 45 V

Forward Current - 10 A

Features

- High forward surge capability
- Ultra low forward voltage drop
- Excellent high temperature stability



Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	45	V
Reverse Voltage	V_R	45	V
Average Rectified Output Current	I_o	10	A
Non-repetitive Peak Forward Surge Current ($t = 8.3 \text{ ms}$)	I_{FSM}	180	A
Operating Temperature Range	T_J	- 65 to + 150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 175	$^\circ\text{C}$

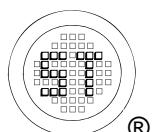
Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient ¹⁾	$R_{\theta JA}$	102	$^\circ\text{C/W}$

¹⁾FR-4 PCB, 2OZ.Copper. minimum recommended pad layout

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 500 \mu\text{A}$	$V_{(BR)R}$	45	-	V
Forward Voltage at $I_F = 8 \text{ A}$ at $I_F = 10 \text{ A}$	V_F	- -	0.51 0.55	V
Reverse Current at $V_R = 45 \text{ V}$ at $V_R = 45 \text{ V}, T_J = 85^\circ\text{C}$ at $V_R = 45 \text{ V}, T_J = 125^\circ\text{C}$	I_R	- - -	0.45 10 50	mA



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Electrical characteristics curves

Fig 1. Reverse Characteristics Curve

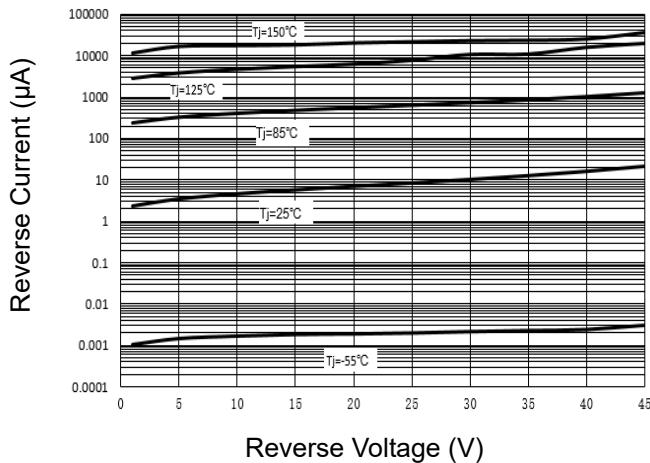


Fig 2. Forward Characteristics Curve

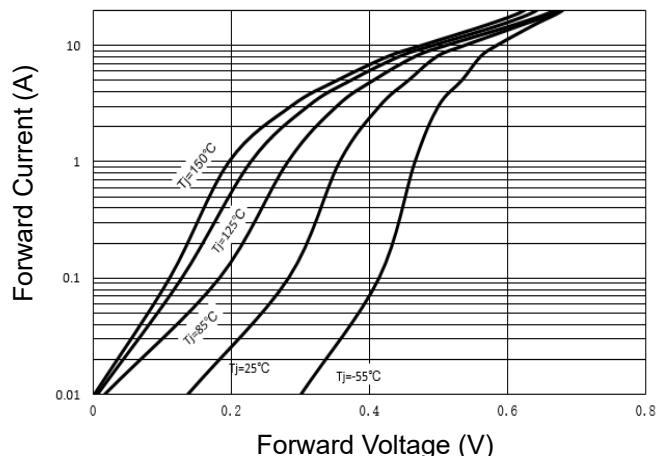


Fig 3. Junction Capacitance

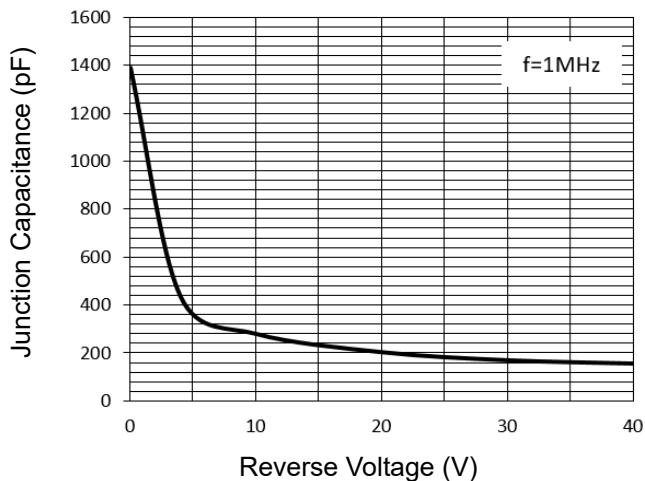
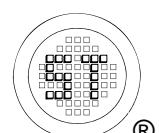
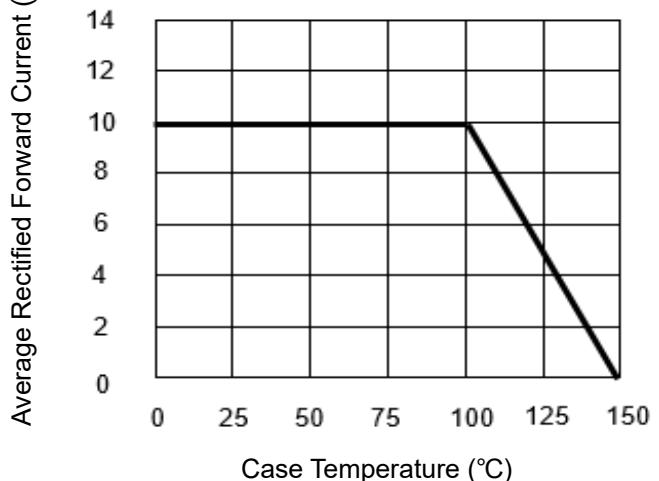


Fig 4. Forward Current Derating Curve

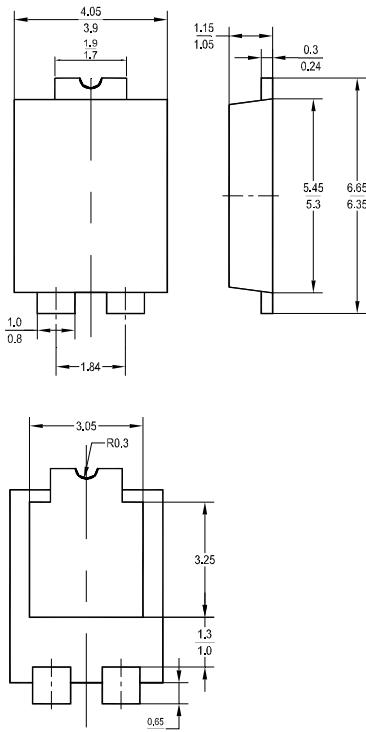


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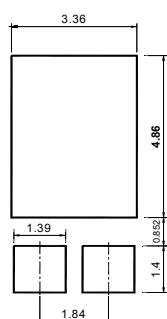
PACKAGE OUTLINE

Plastic surface mounted package (Units: mm)

TO-277



Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
TO-277	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

Marking information

" SDB1045HB " = Part No.

" YYWW " = Date Code Marking

" Y " = Year (ex: 19 = 2019)

" W " = Week (ex: 09 = the 9th week of the year)

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